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Vishay/Siliconix IRF740S

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Datasheet of IRF740S - MOSFET N-CH 400V 10A D2PAK

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IRF740S, SiHF740S

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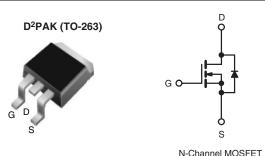
RoHS*

COMPLIANT

HALOGEN FREE

Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	400				
$R_{DS(on)}(\Omega)$	V _{GS} = 10 V 0.55				
Q _g (Max.) (nC)	63				
Q _{gs} (nC)	9.0				
Q _{gd} (nC)	32				
Configuration	Single				



FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- Surface Mount
- Available in Tape and Reel
- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The D²PAK (TO-263) is a surface mount power package capable of accommodating die size up to HEX-4. It provides the highest power capability and the lowest possible on-resistance in any existing surface mount package. The D²PAK (TO-263) is suitable for high current applications because of its low internal connection resistance and can dissipate up to 2.0 W in a typical surface mount application.

ORDERING INFORMATION					
Package	D ² PAK (TO-263)	D ² PAK (TO-263)	D ² PAK (TO-263)		
Lead (Pb)-free and Halogen-free	SiHF740S-GE3	SiHF740STRL-GE3a	SiHF740STRR-GE3a		
Lead (Pb)-free	IRF740SPbF	IRF740STRLPbFa	IRF740STRRPbFa		
Leau (FD)-1166	SiHF740S-E3	SiHF740STL-E3a	SiHF740STR-E3 ^a		

Note

a. See device orientation.

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V_{DS}	400	.,	
Gate-Source Voltage			V_{GS}	± 20	V	
$T_{\rm C} = 25^{\circ}$		T _C = 25 °C	ı	10		
Continuous Drain Current	V _{GS} at 10 V	T _C = 100 °C	I _D	6.3	Α	
Pulsed Drain Current ^a	I _{DM}	40				
Linear Derating Factor				1.0	W/°C	
Linear Derating Factor (PCB Mount)e				0.025	VV/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	520	mJ	
Avalanche Current ^a			I _{AR}	10	Α	
Repetitive Avalanche Energy ^a			E _{AR}	13	mJ	
Maximum Power Dissipation $T_C = 25 ^{\circ}C$			P _D	125	14/	
Maximum Power Dissipation (PCB Mount) ^e $T_A = 25 ^{\circ}\text{C}$				3.1	W	
Peak Diode Recovery dV/dtc			dV/dt	4.0	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg} - 55 to + 150		°C	
Soldering Recommendations (Peak Temperature) for 10 s			Ĭ	300 ^d		

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 9.1 mH, R_g = 25 Ω , I_{AS} = 10 A (see fig. 12).
- c. $I_{SD} \le 10A$, $dI/dt \le 120 A/\mu s$, $V_{DD} \le V_{DS}$, $T_{J} \le 150 \, ^{\circ}C$.
- d. 1.6 mm from case.

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e. When mounted on 1" square PCB (FR-4 or G-10 material).

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^{*} Pb containing terminations are not RoHS compliant, exemptions may apply



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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	62		
Maximum Junction-to-Ambient (PCB Mount) ^a	R _{thJA}	-	40	°C/W	
Maximum Junction-to-Case (Drain)	R _{thJC}	-	1.0		

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		•					
Drain-Source Breakdown Voltage	V _{DS}	V _{GS}	= 0, I _D = 250 μA	400	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 1 mA	-	0.49	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 250 μA	2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}	,	V _{GS} = ± 20 V	-	-	± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}		400 V, V _{GS} = 0 V V, V _{GS} = 0 V, T _J = 125 °C	-	-	25 250	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 6.0 A ^b	-	-	0.55	Ω
Forward Transconductance	9 _{fs}	V _{DS} =	= 50 V, I _D = 6.0 A ^b	5.8	-	-	S
Dynamic		•					
Input Capacitance	C _{iss}		V _{GS} = 0 V,	-	1400	-	pF
Output Capacitance	C _{oss}	1	$V_{DS} = 25 \text{ V},$	-	330	-	
Reverse Transfer Capacitance	C _{rss}	f = 1.	0 MHz, see fig. 5	-	120	-	
Total Gate Charge	Qg		V _{GS} = 10 V		-	63	nC
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V			-	9.0	
Gate-Drain Charge	Q_{gd}		goo ng. o ana 10	-	-	32	
Turn-On Delay Time	t _{d(on)}	V_{DD} = 200 V, I_D = 10 A, R_g = 9.1 Ω , R_D = 20 Ω , see fig. 10 ^b		-	14	-	ns
Rise Time	t _r			-	27	-	
Turn-Off Delay Time	t _{d(off)}			-	50	-	
Fall Time	t _f			-	24	-	
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	nH
Internal Source Inductance	L _S			-	7.5	-	
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	ı	10	A
Pulsed Diode Forward Current ^a	I _{SM}			-	_	40	
Body Diode Voltage	V_{SD}	T _J = 25 °C, I _S = 10 A, V _{GS} = 0 V ^b		-	-	2.0	V
Body Diode Reverse Recovery Time	t _{rr}	T. = 25 °C 1	- 10 A dl/dt - 100 A/vab	-	370	790	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$T_J = 25 ^{\circ}\text{C}, I_F = 10 \text{A}, \text{dl/dt} = 100 \text{A/}\mu\text{s}^b$		-	3.8	8.2	μC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L _S and L _D)				L _D)	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 μ s; duty cycle \leq 2 %.





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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

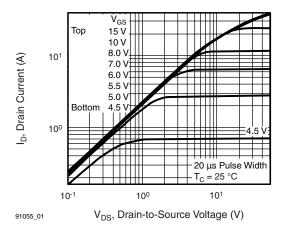


Fig. 1 - Typical Output Characteristics, $T_C = 25$ °C

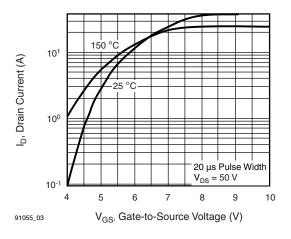


Fig. 3 - Typical Transfer Characteristics

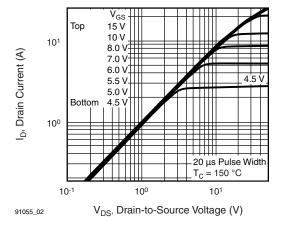


Fig. 2 - Typical Output Characteristics, T_C = 150 °C

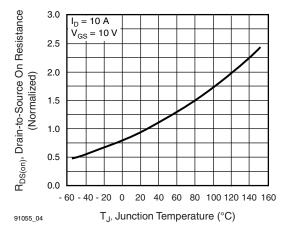


Fig. 4 - Normalized On-Resistance vs. Temperature



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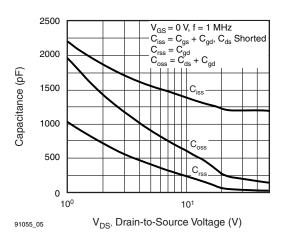


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

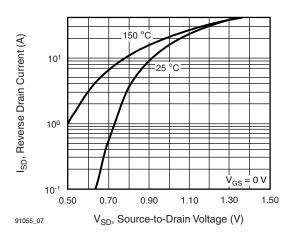


Fig. 7 - Typical Source-Drain Diode Forward Voltage

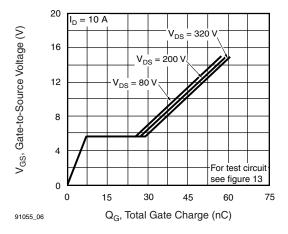


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

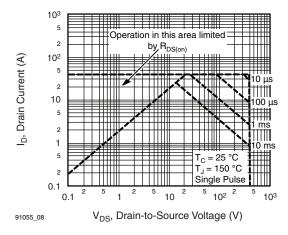


Fig. 8 - Maximum Safe Operating Area



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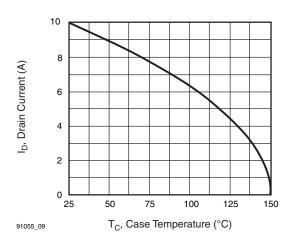


Fig. 9 - Maximum Drain Current vs. Case Temperature

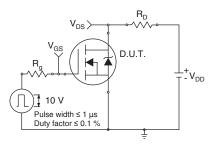


Fig. 10a - Switching Time Test Circuit

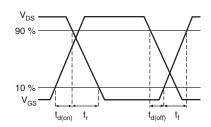


Fig. 10b - Switching Time Waveforms

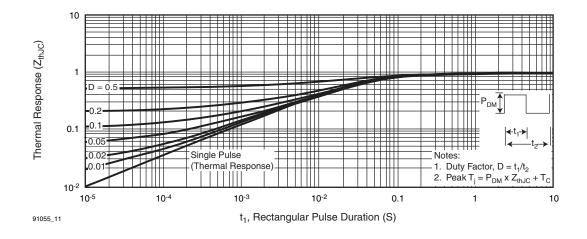


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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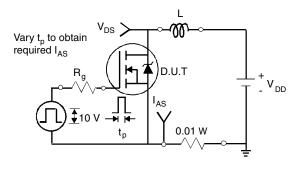


Fig. 12a - Unclamped Inductive Test Circuit

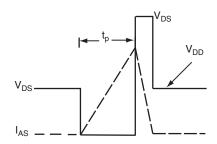


Fig. 12b - Unclamped Inductive Waveforms

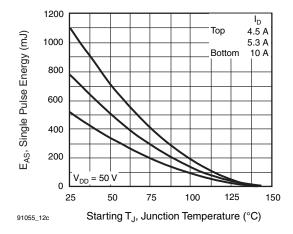


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

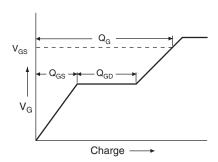


Fig. 13a - Basic Gate Charge Waveform

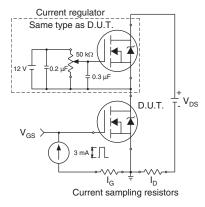


Fig. 13b - Gate Charge Test Circuit





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Peak Diode Recovery dV/dt Test Circuit Circuit layout considerations D.U.T. · Low stray inductance Ground plane · Low leakage inductance current transformer • dV/dt controlled by R_q · Driver same type as D.U.T. V_{DD}

• I_{SD} controlled by duty factor "D" • D.U.T. - device under test

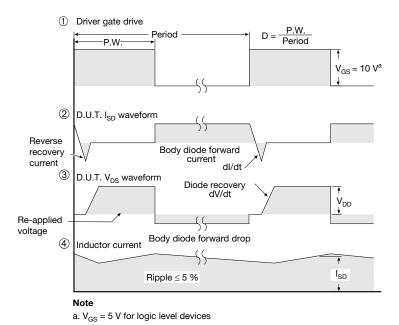


Fig. 14 - For N-Channel

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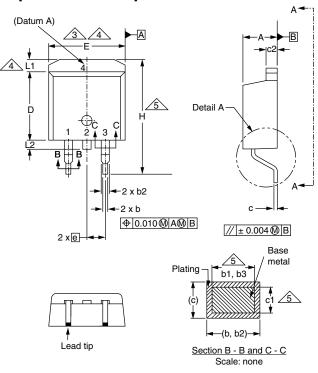
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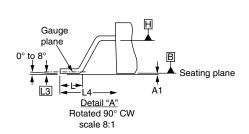


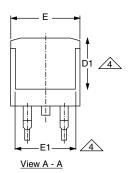
Package Information

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TO-263AB (HIGH VOLTAGE)







			ocale.	
	MILLIN	IETERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
Α	4.06	4.83	0.160	0.190
A1	0.00	0.25	0.000	0.010
b	0.51	0.99	0.020	0.039
b1	0.51	0.89	0.020	0.035
b2	1.14	1.78	0.045	0.070
b3	1.14	1.73	0.045	0.068
С	0.38	0.74	0.015	0.029
c1	0.38	0.58	0.015	0.023

1.65

9.65

0.045

0.330

0.065

0.380

	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
D1	6.86	-	0.270	-
Е	9.65	10.67	0.380	0.420
E1	6.22	-	0.245	-
е	2.54 BSC		0.100 BSC	
Н	14.61	15.88	0.575	0.625
L	1.78	2.79	0.070	0.110
L1	-	1.65	-	0.066
L2	-	1.78	-	0.070
L3	0.25 BSC		0.010	BSC
L4	4.78	5.28	0.188	0.208

8.38 ECN: S-82110-Rev. A, 15-Sep-08

1.14

DWG: 5970

c2

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimensions are shown in millimeters (inches).
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.
- 4. Thermal PAD contour optional within dimension E, L1, D1 and E1.
- 5. Dimension b1 and c1 apply to base metal only.
- 6. Datum A and B to be determined at datum plane H.
- 7. Outline conforms to JEDEC outline to TO-263AB.

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